

ML9489

Static, 1/2 Duty, 1/3 Duty, 1/4 Duty 160 Outputs LCD Driver

GENERAL DESCRIPTION

The ML9489 is an LCD driver LSI, consists of a 160-bit shift register, a 640-bit data latch, 160 sets of LCD drivers, and a common signal generation circuit.

It can directly drive an LCD up to 160 segments for static display, 320 segments for 1/2-duty display, 480 segments for 1/3-duty display, and 640 segments for 1/4-duty display.

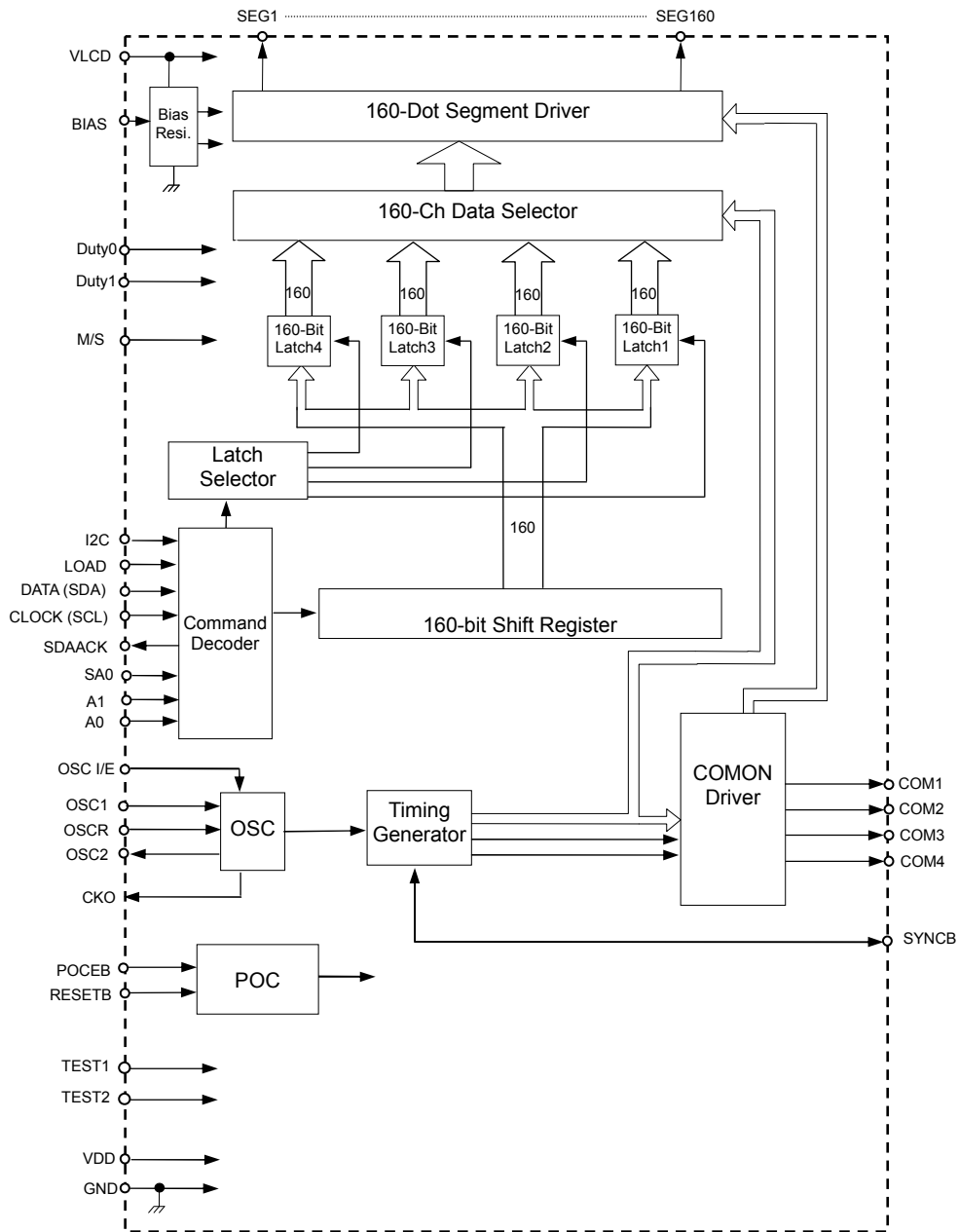
The three-wire serial interface and I²C interface are selectable.

FEATURES

- Logic power supply voltage : 2.7 to 5.5 V
- LCD drive power supply voltage : 4.5 to 5.5 V
- Maximum number of segments
 - Static display : 160 segments
 - 1/2-duty display : 320 segments
 - 1/3-duty display : 480 segments
 - 1/4-duty display : 640 segments
- Interface with microcomputer :
 - Serial interface : DATA, CLOCK, LOAD
CLOCK transfer speed up to 1 MHz
 - I²C interface : SDA, SCL, SDAACK
SCL transfer speed up to 400 kHz
- Built-in CR oscillator circuit using the internal resistor or External resistor
- Cascade connectable (up to eight chips)
- Built-in common signal generation circuit
- Built-in common output intermediate-value voltage generation circuit
- Built-in POC (Power On Clear) circuit
- Gold bump chip (ML9489DVWA)
- Comparison table

| Item | ML9479EDVWA | ML9489DVWA |
|---|---------------------------------------|---|
| Frame Frequency (Internal oscillation) | 65Hz/75Hz/85Hz/95Hz (programmable) | 130Hz/150Hz/170Hz/190Hz (programmable) |

BLOCK DIAGRAM



ABSOLUTE MAXIMUM RATINGS

| Item | Symbol | Condition | Rating | Unit |
|--------------------------------|------------------|-----------------------|--------------------------------|------|
| Logic power supply voltage | V _{DD} | T _a = 25°C | -0.3 to 6.0 | V |
| LCD drive power supply voltage | V _{LCD} | T _a = 25°C | -0.3 to 6.0 | V |
| Input voltage | V _I | T _a = 25°C | - 0.3 to V _{DD} + 0.3 | V |
| Output short-circuit current | I _S | T _a = 25°C | -2.0 to +2.0 | mA |
| Chip temperature | T _C | — | 125 | °C |
| Storage temperature | T _{STG} | — | -55 to +150 | °C |

Note: Do not use the ML9489 by short-circuiting one output pin to another output pin as well as to other pin (input pin, input/output pin, or power supply pin).

RECOMMENDED OPERATION CONDITIONS

| Item | Symbol | Condition | Range | Unit |
|--------------------------------|--------------------|-----------|-------------|------|
| Logic power supply voltage | V _{DD} * | — | 2.7 to 5.5 | V |
| LCD drive power supply voltage | V _{LCD} * | — | 4.5 to 5.5 | V |
| OSC IN clock frequency | f _{CP1} | — | up to 10 | kHz |
| Data clock frequency | f _{CP2} | — | up to 1.0 | MHz |
| SCL clock frequency | f _{SCL} | — | up to 400 | kHz |
| Operating temperature | T _a | — | -40 to +105 | °C |

Note(*): Use at V_{DD} ≤ V_{LCD}.

The relation between OSC IN clock frequency and frame frequency is as the equation below.

$$f_{\text{FRM}} = f_{\text{OSC}} / 24$$

Recommended setting range for external component (oscillator circuit)

(V_{DD} = 2.7 to 5.5 V, V_{LCD} = 4.5 to 5.5 V, T_a = -40 to +105°C)

| Item | Symbol | Condition | Min | TYP | Max | Unit |
|----------------------|------------------|---------------|-----|-----|-----|------|
| Oscillation resistor | R _f | — | 423 | 470 | 517 | kΩ |
| Frame frequency | f _{FRM} | (F1,F0)=(0,1) | 47 | 75 | 114 | Hz |

The relation between oscillation resistor and frame frequency is as the equation below.

$$f_{\text{FRM}} = f_{\text{OSC}} / (8 \times 24)$$

$$f_{\text{OSC}} = 1 / (\text{Device coefficient} \times \text{External resistor } R_f)$$

$$\text{Device coefficient} = 73.8 \times 10^{-12} \pm 25\%$$

ELECTRICAL CHARACTERISTICS

DC Characteristics

($V_{DD} = 2.7$ to 5.5 V, $V_{LCD} = 4.5$ to 5.5 V, $T_a = -40$ to $+105^\circ\text{C}$)

| Item | Symbol | Condition | Min. | Typ. | Max. | Unit | Applicable pin | |
|-------------------------|-----------|--|-----------------|------|-------------|---------------|----------------|----------------|
| "H" input voltage | V_{IH} | — | $0.8V_{DD}$ | — | V_{DD} | V | (*1) | |
| "L" input voltage | V_{IL} | — | GND | — | $0.2V_{DD}$ | V | (*1) | |
| Input leakage current 1 | I_{L1} | $V_I = V_{DD}$ or 0 V | -1.0 | — | 1.0 | μA | (*1) | |
| Input leakage current 2 | I_{L2} | $V_I = V_{DD}$ or 0 V POCEB = "H" | -1.0 | — | 1.0 | μA | RESETB | |
| Pull-up current | I_{pu} | $V_{DD} = 5.0$ V, $V_I = 0$ V POCEB = "L" | 30 | — | 140 | μA | RESETB | |
| "H" output voltage | V_{OH} | $I_O = -600\mu\text{A}$ | $0.9V_{DD}$ | — | — | V | CKO, SYNCB | |
| "L" output voltage 1 | V_{OL1} | $I_O = 600\mu\text{A}$ | — | — | $0.1V_{DD}$ | V | CKO, SYNCB | |
| "L" output voltage 2 | V_{OL2} | $I_O = 600\mu\text{A}$ | — | — | $0.1V_{DD}$ | V | SDAACK | |
| Driver ON resistor | Segment | V_{OHS} | $V_{LCD} = 5$ V | — | 5 | 15 | $k\Omega$ | SEG1 to SEG160 |
| | Common | V_{OHC} | $V_{LCD} = 5$ V | — | 5 | 12 | $k\Omega$ | COM 1 to COM4 |

(*1): DATA(SDA), CLOCK(SCL), LOAD, M/S, SYNCB, Duty1, Duty0, BIAS, SA0, A1, A0, OSC1, OSC I/E, I2C, POCEB

($V_{DD} = 2.7$ to 5.5 V, $V_{LCD} = 4.5$ to 5.5 V, $T_a = -40$ to $+105^\circ\text{C}$)

| Item | Symbol | Condition | Min. | Typ. | Max. | Unit | Applicable pin | |
|--------------------------|------------|---|------|------|------|---------------|----------------|------|
| Static supply current | I_{DD5} | $V_{DD}=V_{LCD}=5.5$ V Input pin fixed to "H" or "L" | — | 8 | 15 | μA | VDD | |
| | I_{LCD5} | Oscillation stopped, output no-load POCEB="L" | — | 9 | 15 | μA | VLCD | |
| Dynamic supply current 1 | I_{DD1} | $V_{DD}=V_{LCD}= 5.5$ V (*2)(*3) Clock OSC1 external input | (*6) | — | 12 | 22 | μA | VDD |
| | I_{LCD1} | $f_{CP1}=1.8$ kHz | (*7) | — | 11 | 19 | μA | VLCD |
| Dynamic supply current 2 | I_{DD2} | $V_{DD}=V_{LCD}= 5.5$ V (*2)(*3) Internal oscillation | (*6) | — | 67 | 94 | μA | VDD |
| | I_{LCD2} | | (*7) | — | 11 | 19 | μA | VLCD |
| Dynamic supply current 3 | I_{DD3} | $V_{DD}=V_{LCD}= 5.5$ V (*2)(*4)(*6) Internal oscillation | — | 202 | 304 | μA | VDD | |
| | I_{LCD3} | At three-wire serial IF data input | — | 11 | 19 | μA | VLCD | |
| Dynamic supply current 4 | I_{DD4} | $V_{DD}=V_{LCD}= 5.5$ V (*2)(*5)(*6) Internal oscillation | — | 232 | 354 | μA | VDD | |
| | I_{LCD4} | At I ² C IF data input | — | 11 | 19 | μA | VLCD | |

(*2): M/S = "H", 1/4-duty, 1/3-bias, (F1,F0) = (1,1) 190 Hz, POCEB = "L", output pin no-load.

(*3): Three-wire serial or I²C interface. Input pin fixed to "H" or "L".

(*4): Serial interface, data input frequency = 1 MHz.

(*5): I²C interface, data input frequency = 400 kHz.

(*6): Alternately inputs "0" and "1" for LCD display data (checkered display).

(*7): Inputs all "1s" for LCD display data (all illuminated).

Switching Characteristics

- OSC timing

($V_{DD} = 2.7$ to 5.5 V, $V_{LCD} = 4.5$ to 5.5 V, $T_a = -40$ to $+105^\circ\text{C}$)

| Item | Symbol | Condition | Min. | Typ. | Max. | Unit | Applicable pin |
|--|------------|--|------|------|------|---------------|---------------------|
| OSC IN clock frequency (external input) | f_{CP1} | Clock input from OSC1. OSC2 and OSCR open. OSC I/E = "L" | — | 1.8 | 10 | kHz | OSC1 |
| Clock pulse width (External input) | t_{WCP1} | | 40 | — | — | μs | OSC1 |
| Clock rise and fall time (external input) | t_{OSC} | | — | — | (*1) | μs | OSC1 |
| External Rf clock frequency (Internal oscillation) | f_{OSC1} | Between OSC1 and OSC2 $R_f = 470\text{k}\Omega$ (F1,F0)=(0,1) OSCR open. OSC I/E = "H" | 18 | 28.8 | 44 | kHz | OSC1, OSC2 |
| Internal clock frequency (Internal oscillation) | f_{OSC2} | OSC1 open. (F1,F0)=(0,1) OSC2 and OSCR short-circuited. OSC I/E = "H" | 18 | 28.8 | 44 | kHz | OSC1, OSCR, OSC2 |

The relation between OSC IN clock frequency and frame frequency is as the equation below.

$$f_{FRM} = f_{OSC} / 24$$

(*1) t_{OSC} is a reference value.

The longer the clock rise and fall time, the more susceptible to extraneous noises around the threshold value.
Make the rise as steep as possible. Reference value: $\text{max}=2\mu\text{s}$.

- Serial interface timing

($V_{DD} = 2.7$ to 5.5 V, $V_{LCD} = 4.5$ to 5.5 V, $T_a = -40$ to $+105^\circ\text{C}$)

| Item | Symbol | Condition | Min. | Typ. | Max. | Unit | Applicable pin |
|---------------------------|------------------|-----------|------|------|------|------|----------------------|
| Data clock frequency | f_{CP2} | | — | — | 1 | MHz | CLOCK |
| Data clock pulse width | t_{WCP2} | | 100 | — | — | ns | CLOCK |
| Data setup time | t_{SU} | | 50 | — | — | ns | DATA |
| Data hold time | t_{HD} | | 50 | — | — | ns | CLOCK |
| CLOCK-LOAD timing | t_{CL} | | 100 | — | — | ns | CLOCK |
| LOAD-CLOCK timing | t_{LC} | | 100 | — | — | ns | LOAD |
| LOAD pulse width | t_{WLD} | | 100 | — | — | ns | LOAD |
| Signal rise and fall time | t_{sr}, t_{sf} | | — | — | (*2) | ns | CLOCK, DATA, LOAD |

(*2) t_{sr} and t_{sf} shall be reference values.

The longer the clock rise and fall time, the more susceptible to extraneous noises around the threshold value.
Make the rise as steep as possible. Reference value: $\text{max}=10\text{ns}$.

- I²C interface timing

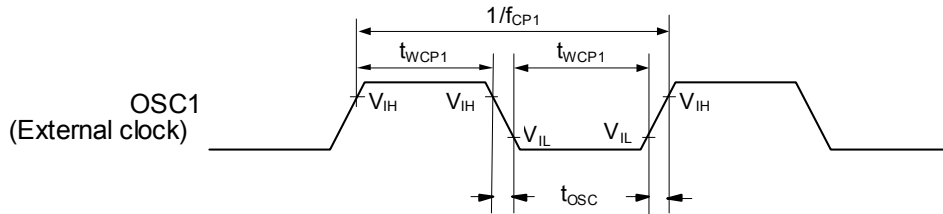
(V_{DD} = 2.7 to 5.5 V, V_{LCD} = 4.5 to 5.5 V, Ta = -40 to +105°C)

| Item | Symbol | Condition | Min. | Typ. | Max. | Unit | Applicable pin |
|--|---------------------|-----------|------|------|------|------|----------------|
| SCL clock frequency | f _{SCL} | | — | — | 400 | kHz | SCL |
| Hold time (repeat) "STATRT" condition | t _{HD,STA} | | 0.6 | — | — | μs | SCL,SDA |
| SCL "L" pulse width | t _{LOW} | | 1.3 | — | — | μs | SCL |
| SCL "H" pulse width | t _{HIGH} | | 0.6 | — | — | μs | SCL |
| Setup time for repeat "START" condition | t _{SU,STA} | | 0.6 | — | — | μs | SCL,SDA |
| Data hold time | t _{HD,DAT} | | 0 | — | — | ns | SCL,SDA |
| Data setup time | t _{SU,DAT} | | 200 | — | — | ns | SCL,SDA |
| Setup time for "STOP" condition | t _{SU,STO} | | 0.6 | — | — | μs | SCL,SDA |
| Bus free time between "STOP" condition and "START" condition | t _{BUF} | | 1.3 | — | — | μs | SCL |
| Data valid acknowledge time | t _{VD,ACK} | | — | — | 1.2 | μs | SCL,SDAAACK |
| Signal rise and fall time | t _{ir,tif} | | — | — | (*3) | μs | SCL,SDA |
| Data bus load capacitance | C _b | | — | — | 400 | pF | SDA,SDAAACK |
| Noise pulse width tolerance | t _{wf} | | — | — | 50 | ns | SCL,SDA |

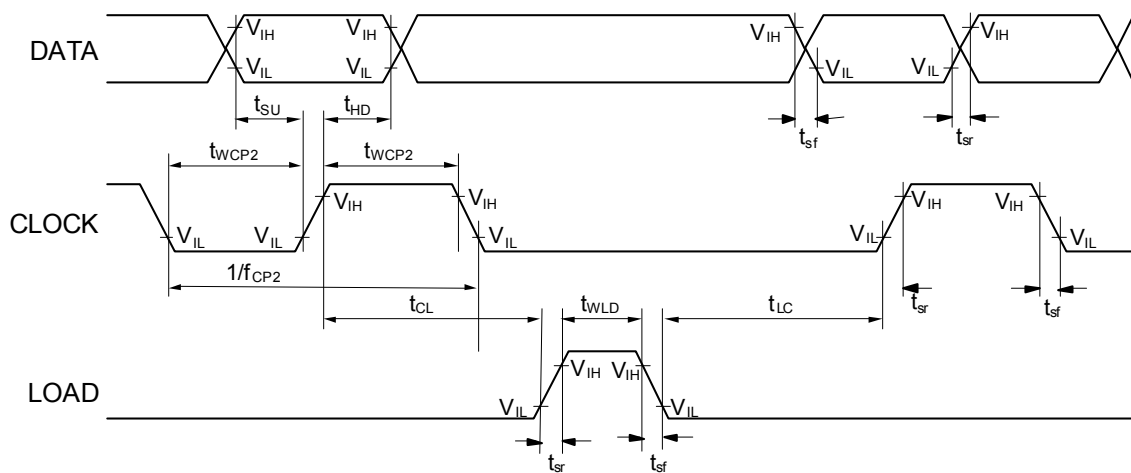
(*3) t_{ir} and t_{tif} shall be reference values.

The longer the clock rise and fall time, the more susceptible to extraneous noises around the threshold value.
Make the rise as steep as possible. Reference value: max=0.1μs.

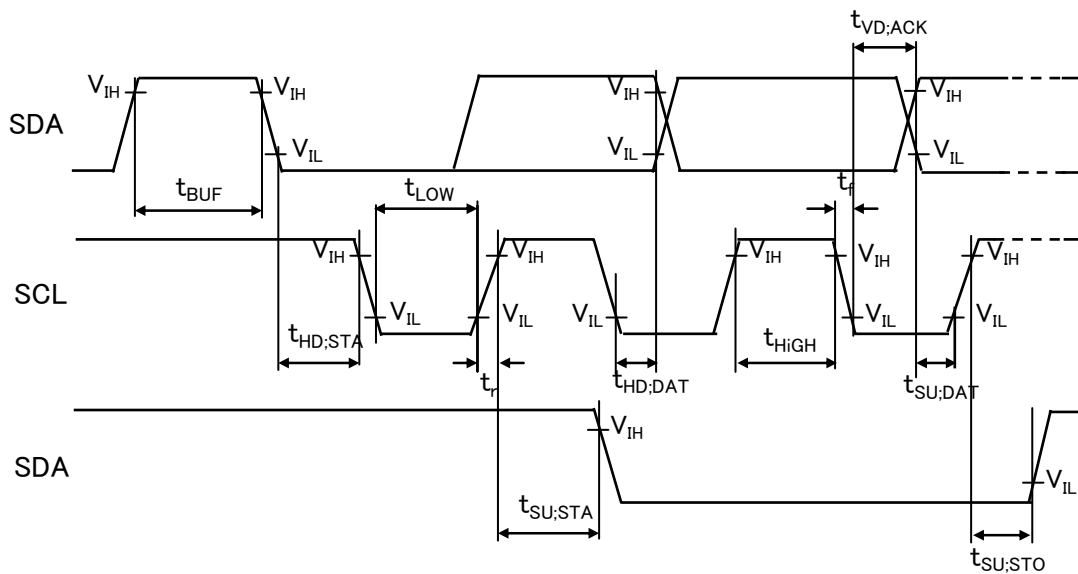
Timing chart (OSC1)



Timing chart (Serial interface)



Timing chart (I²C interface)



REFERENCE DATA

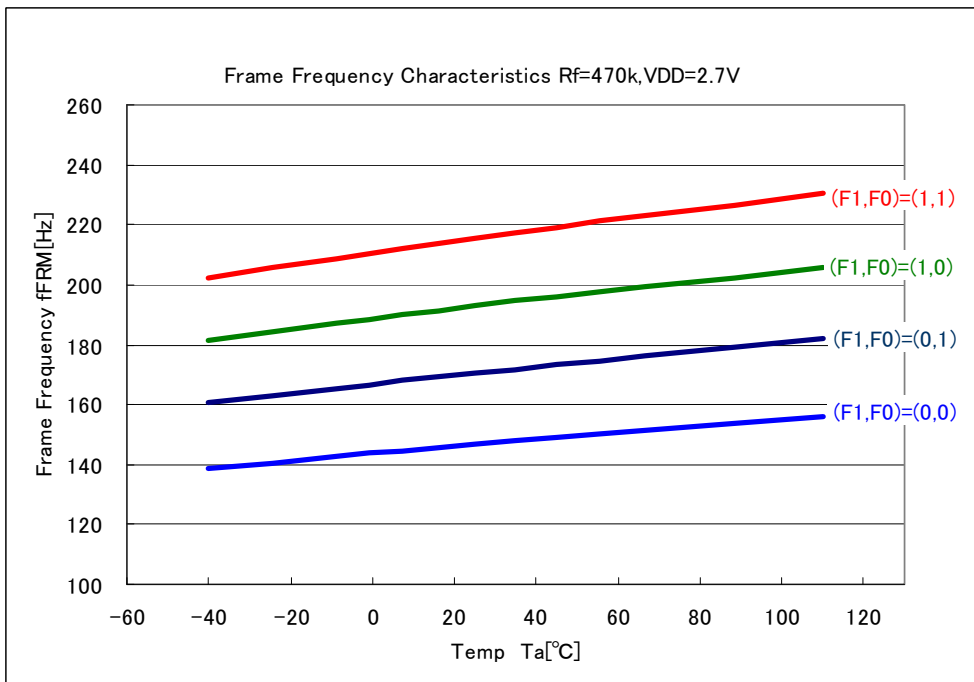
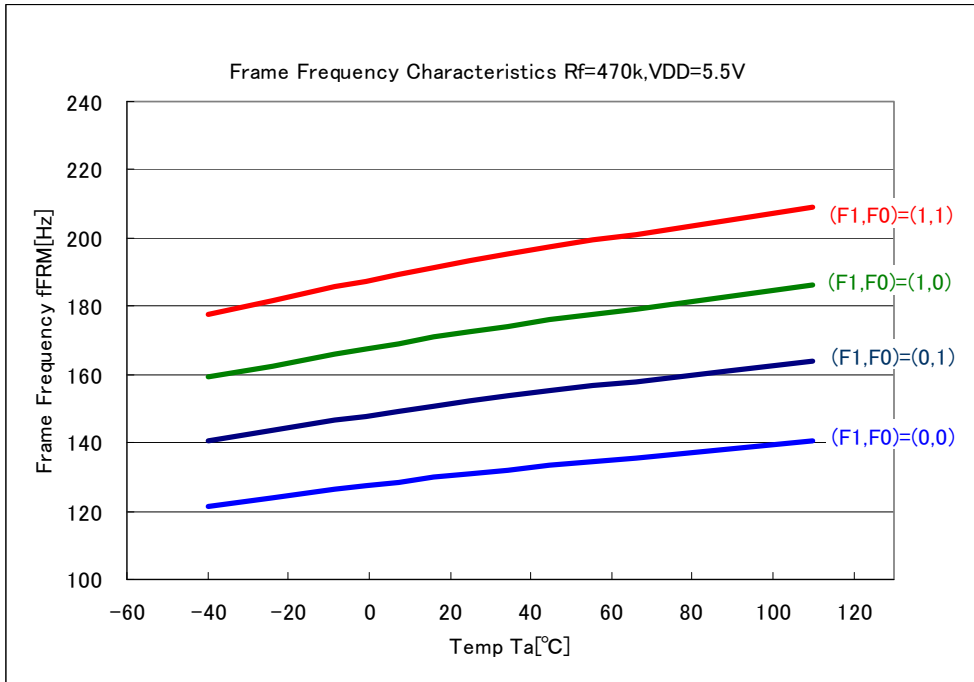
Frame frequency Characteristics

VDD=5.5V/2.7V Rf=470kΩ

Frame frequency $f_{FRM} = f_{OSC} / (8 \times 24)$

$f_{osc} = 1 / (\text{Device coefficient} \times \text{External resistor } R_f)$

Device coefficient = $73.8 \times 10^{-12} \pm 25\%$



POWER ON/OFF TIMING

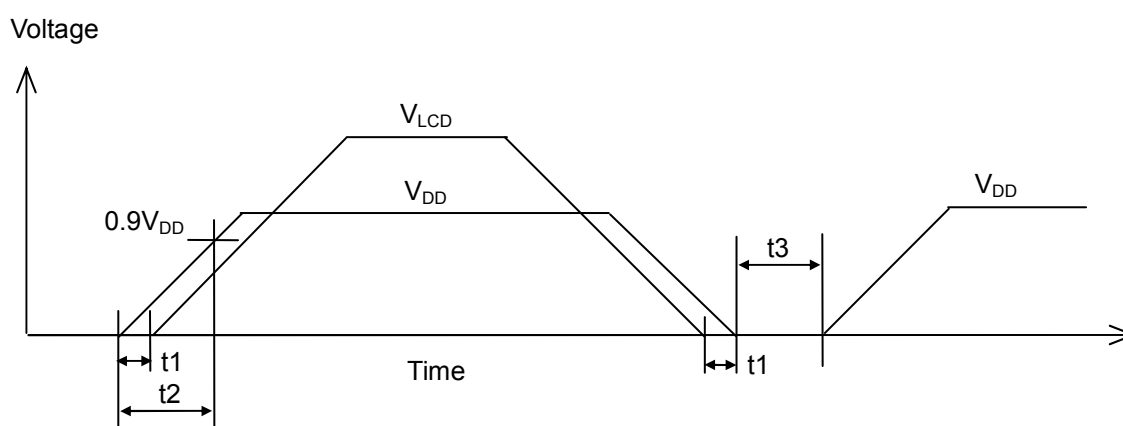
To turn on the power supply, raise the logic power supply first, then LCD drive power supply in order to prevent the IC from malfunctioning.

To fall the power supply, fall the LCD drive power supply first, then the logic power supply.

For a VDD pin ranging from 0 V to VDDmin, set $VDD \geq VLCD$ and $t1 \geq 0$ [ns].

To enable the Internal POC circuit, the VDD power supply rise time $t2$ range needs to be $100 [\mu s] \leq t2 \leq 500$ [ms].

For the VDD power supply to turn OFF then turn ON again, it is necessary to secure the POC discharge time $t3 \geq 100$ [ms].

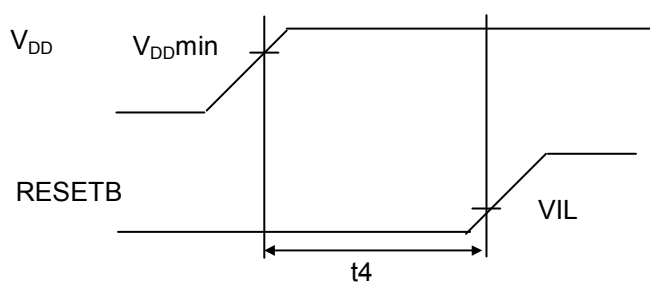


INITIALIZATION SIGNAL TIMING

When RESETB signal is externally input

The RESETB pin input is valid both for POCEB = "L" and "H". Usable in combination with the POC.

Keep the RESETB pin at "L" level until the VDD reaches VDDmin. ($t4 \geq 200$ [ns])



When Internal POC circuit is used

When using the Internal POC circuit in the initialization, set the POCEB pin to "L".

Leave the RESETB pin open.

PIN DESCRIPTIONS

| Pad number | Symbol | I/O | Description |
|-------------------------|------------------------------|-------------|--|
| 109-112 | M/S | I | This is the input to switch between the master and slave modes. It has a schmitt circuit. When this pin is "H", the mode is master. When this pin is "L", the mode is slave. |
| 9-12 13-16 | Duty0 Duty1 *1 | I | Display duty switch pins. These have schmitt circuits. Duty0="L", Duty1="L" : Static (COM1=COM2=COM3=COM4) Duty0="H", Duty1="L" : 1/2Duty (COM1=COM3, COM2=COM4) Duty0="L", Duty1="H" : 1/3Duty (COM2=COM4) Duty0="H", Duty1="H" : 1/4Duty |
| 121-124 | BIAS | I | This pin sets the LCD bias. It has a schmitt circuit. BIAS="L": 1/3bias BIAS="H": 1/2bias When the static mode selection, fix this pin at "H" or "L" level. |
| 25-28 | SA0 | I | Slave address input pin. It has a schmitt circuit. |
| 17-20 21-24 | A1 A0 | I | Sub address input pins. These have schmitt circuits. |
| 117-120 | OSC I/E | I | This input selects whether to use the external clock input mode or to use the Internal oscillation mode or external oscillation mode. It has a schmitt circuit. When this pin is "H", the mode is the Internal or external Rf oscillation mode. When this pin is "L", the mode is the external clock input mode. Use the slave chip as it is connected to GND. |
| 78-82 83-87 88-82 | OSC1, OSCR, OSC2 *2 | I I O | These pins are for the oscillator circuit to generate common signals. The OSC1 and OSC2 pins are input pins and have a schmitt circuit. OSC2 is an output pin. It becomes an output when the OSC I/E pin = "H" and a high impedance when the OSC I/E pin = "L". 【 In the master mode (M/S pin = "H") 】 Three types are selectable: Internal oscillation mode, external oscillation mode, and external clock input mode. •Internal oscillation mode: Set the OSC I/E pin to "H", short the OSC2 and OSC2 pins, and open the OSC1 pin. •External Rf oscillation mode: Set the OSC I/E pin to "H", connect an oscillation resistor Rf between the OSC1 and OSC2 pins, and open the OSC2 pin. •External clock input mode: Set the OSC I/E pin to "L", open the OSC2 and OSC2 pins, and input the external clock to the OSC1 pin. 【 In the slave mode (M/S pin = "L") 】 Open the OSC2 and OSC2 pins and connect the OSC1 pin to the ML9489's CKO pin that has been set to the master mode. |
| 93-97 | CKO | O | Clock output pin. In the master mode (M/S pin = "H"), the 1/16 division signal of the oscillation frequency is output. In the slave mode (M/S pin = "L"), the output is fixed to "L". For a cascade connection, connect this pin to the OSC1 pin of the chip that has been set to the slave mode. |

| | | | |
|---------|--------------|-----|--|
| 98-102 | SYNCB | I/O | Input/output pin for common synchronization. It has a schmitt circuit. It becomes the synchronization signal output pin in the master mode (M/S pin = "H"). It becomes the synchronization signal input pin in the slave mode (M/S pin = "L"). For cascade connection, connect all of the involved ML9489s' SYNC pins by the common line. |
| 105-108 | I2C | I | Interface switching pin. It has a schmitt circuit. When this pin is "H", the interface is I ² C. When this pin is "L", the interface is three-wire serial. |
| 36-40 | DATA (SDA) | I | Display data input pin. It has a schmitt circuit. I2C="L": Serial interface; DATA Input the display data in the order of SEG160, SEG159, ... , SEG2, and SEG1. The display data turns on at "H" and turns off at "L". I2C="H": I ² C interface; SDA Input the display data in units of 8 bits. The display data turns on at "H" and turns off at "L". This pin has a built-in noise filter through which noises in widths up to 50 ns are removed. This noise filter is valid only when I2C = "H". |
| 41-45 | CLOCK (SCL) | I | Shift clock input pin for display data. It has a schmitt circuit. I2C="L": Serial interface; CLOCK The display data input to the DATA pin is serially input to the shift register at the CLOCK signal rise. I2C="H": I ² C interface; SCL The display data input to the SDA pin is serially input to the shift register at the SCL signal rise. This pin has a built-in noise filter through which noises in widths up to 50 ns are removed. This noise filter is valid only when I2C = "H". |
| 46-50 | LOAD | I | Input pin for the load signal of display data. It has a schmitt circuit. I2C="L": Serial interface; LOAD The display data in the shift register is transmitted as is to the segment driver for the "H" duration. When this pin is brought into "L", the shift register is disconnected from the segment driver. The display data in the shift register immediately before it become "L" is held in the data latch and transmitted to the segment driver. I2C="H": I ² C interface Use this pin as it is connected to GND. |
| 31-35 | SDAACK | O | I2C="L": Serial interface Use this pin as it is opened. I2C="H": I ² C interface The I ² C bus acknowledge output signal. Normally, use it as it is connected with the SDA pin. Connect an external pull-up resistor whenever necessary, as it is an open drain pin. The pull-up connection destination supply voltage shall be the V _{DD} supply voltage or less. |
| 113-116 | POCEB | I | Internal POC circuit enable pin. It has a schmitt circuit. When this pin is "H", the POC circuit becomes OFF and the constant current (8μA) is cut. The RESETB pin pull-up resistor is cut as well. When this pin is "L", the POC circuit becomes ON. The RESETB pin is connected to a pull-up resistor. |
| 73-77 | RESETB *3 | I | Reset signal input pin for initializing inside the IC. It has a schmitt circuit. The "L" level enables the reset. This pin has an Internal pull-up resistor. When POCEB = "H", input the external reset signal to this pin. When POCEB = "L", the power-on reset operation is available by open this pin. |

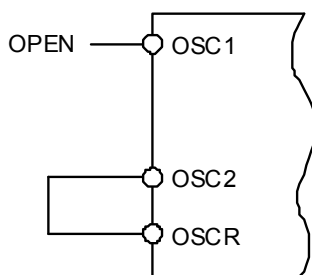
| | | | |
|---|-----------------|---|--|
| 125-128 129-132 | TEST1 TEST2 | I | Pin for testing the IC. These have Internal pull-down resistors. Use it as it is connected to GND. |
| 155-234 239-318 | SEG1 ~SEG160 | O | Outputs for LCD display. Connected to the segment pins on the LCD panel. In the display off mode, all the outputs are fixed to GND. |
| 143-146 235-238 326-329 | COM1 ~COM4 | O | Outputs for LCD display. Connected to the common pin on the LCD panel. The output pins are located at three positions: both ends of the chip and between SEG80 and SEG81. Each is connected inside the chip. Use the COM pins in accordance with the panel to be used. In the display off mode, all the outputs are fixed to GND. When the slave is set (M/S="L"), connecting SYNCB signals enables the master chip to synchronize with common outputs. |
| 59-65 | VDD | - | Power supply pin for logic circuit. |
| 66-72 | VLCD | - | Power supply pin for LCD driver. |
| 51-58 | GND | - | Ground pin. |
| 29-30 103-104 | VDDO | - | VDD output pin. Use this pin when fixing the mode setting input pin to "H" on the COG. |
| 7-8 133-134 | GNDO | - | Ground output pin. Use this pin when fixing the mode setting input pin to "L" on the COG. |
| 1-6 135-142 147-154 319-325 330-331 | DUMMY | - | Floating pin. At this time, avoid this pin from shorting with pins other than DUMMY in the wiring on the COG. |

*1: For details of the COM and SEG waveform when a duty is selected, refer to "Common waveform" on page 18 and "Common Segment waveform" on page 19 to 23.

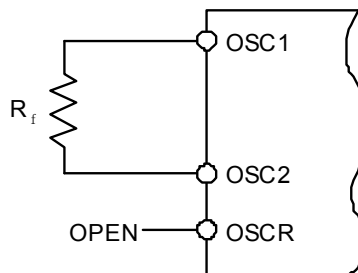
*2: Oscillator circuit configuration

- When M/S = "H", OSC I/E = "H"

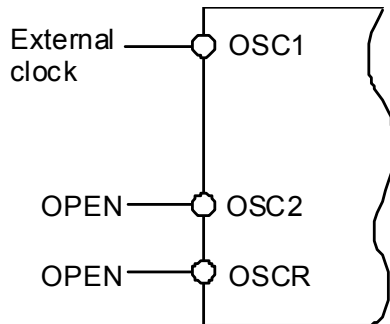
[Internal Rf oscillation mode]



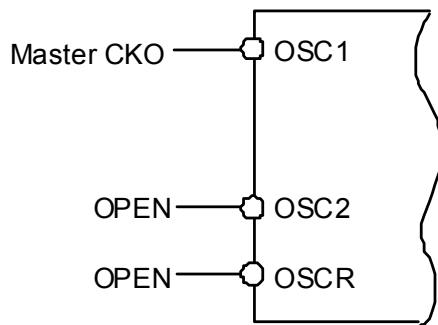
[External Rf oscillation mode]



- External clock input mode when M/S = "H" and OSC I/E = "L"

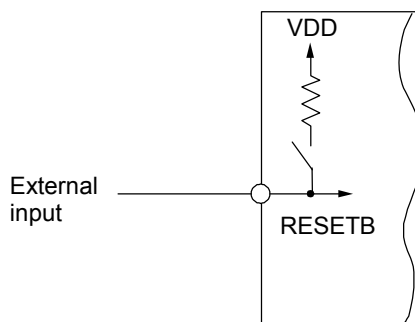


- M/S = "L", slave mode, external clock input mode

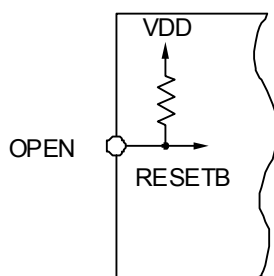


*3: Reset circuit configuration

- External input to RESTB when POCEB = "H"



- POC circuit configuration when POCEB = "L"

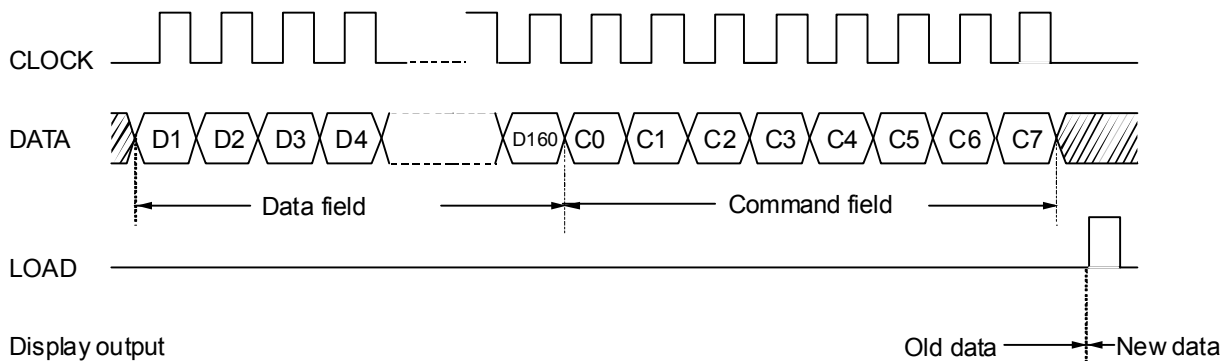


DESCRIPTION

Operation description (Serial interface)

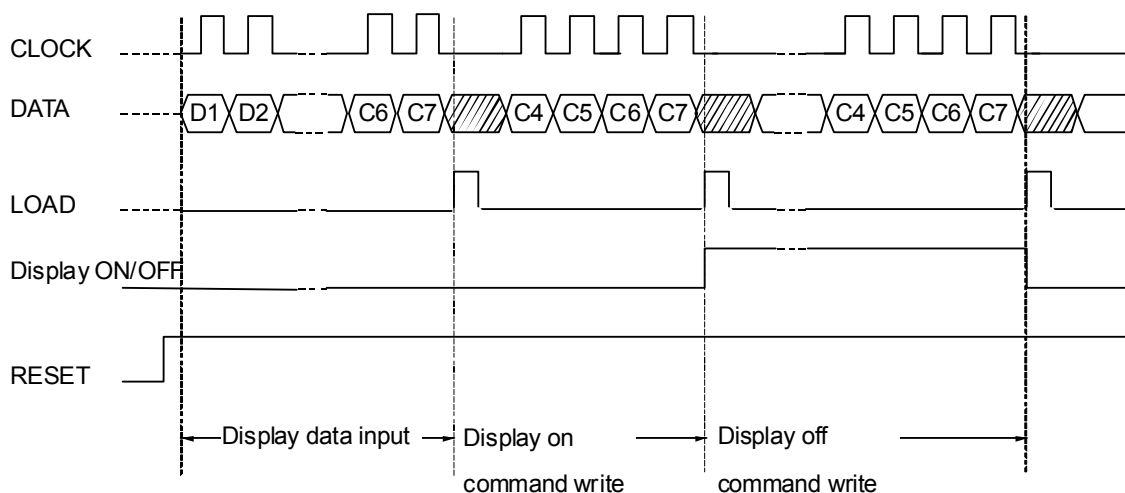
• Display data input

As described in the Data configuration section, the display data consists of the data field that corresponds to each segment on/off and the command field that indicates the display data input. When inputting the display data, the "F3" command is set in the command field. When the "F1" or "F2" command is set in the command field, the display data in the data field becomes invalid. The data input to the DATA pin is loaded to the shift register at the CLOCK pulse rise, transferred to the display data latch during the LOAD pulse at the "H" level, then output via the segment driver.



• Display on, Display off

The display becomes off at power-on reset. To display, write the display on command. The display off is the command that makes all segments off. Writing the display off command, turns off the lights regardless of the display data. The display on is the command to release the display off. Writing the display on command returns the display to the original state.



List of Commands

| Command name | C7 | C6 | C5 | C4 | C3 | C2 | C1 | C0 | Operation |
|--------------|----|----|---------|---------|----|----|-----|-----|--|
| F0 | 0 | 0 | 0 | 0 | x | x | x | x | Disabled |
| F1 | 0 | 1 | F1 (*2) | F0 (*2) | x | x | x | x | Frame frequency setting (F1,F0)=(0, 0): 130Hz (F1,F0)=(0, 1): 150Hz (F1,F0)=(1, 0): 170Hz (F1,F0)=(1, 1): 190Hz (valid for Internal CR oscillation) |
| F2 | 1 | 0 | 1 | D (*2) | x | x | x | x | Display on/off "0": Off (COM=SEG=GND) "1": On |
| F3(*1) | 1 | 1 | SA1 | SA0 | A1 | A0 | Co1 | Co0 | Data write address setting (Co1,Co0)=(0, 0): Corresponding to common 1 (Co1,Co0)=(0, 1): Corresponding to common 2 (Co1,Co0)=(1, 0): Corresponding to common 3 (Co1,Co0)=(1, 1): Corresponding to common 4 SA1, SA0, A1, A0: Chip address |

x: Don't care

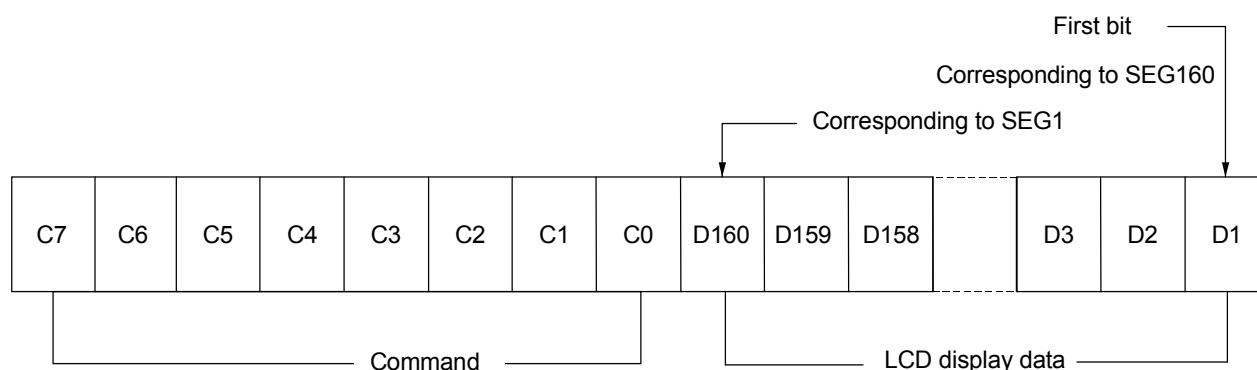
(*1): For the I²C interface, SA0 is set at a slave address.
These bits become "Don't care".

In the ML9489, set the SA1 address to "1".

(*2): The register is set to the following value by the RESETB = "L" input or by the power-on POC.
F1="0", F0="0", D="0"

Data configuration

- Data configuration (Serial interface)

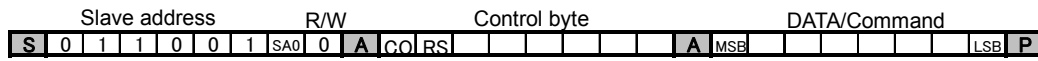


Note 1 : The commands F1 and F2 settings become valid when the least four bits of C4 to C7 are input.
(The bits from D1 to D160 and from C0 to C3 are not necessary.)

Note 2 : If the dummy bit is needed for the reason of number of transfer bits, put it on the first bit side.

Note 3 : The command execution follows the contents of the C7 to C0 registers immediately before the LOAD becomes "H".

• Data configuration (I²C interface)



Slave address: 0 1 1 0 0 1

CO: Consecutive control byte setting bit
 0: Last control byte, 1: Consecutive control byte
 RS: Command/data setting bit
 0: Command data, 1: Display data

For the I²C interface, each IC is assigned with a 7-bit slave address. The first one byte in the transfer consists of this 7-bit slave address and the R/W bit that indicates the data transfer direction. Always input "0" to the eighth R/W bit because the ML9489 is a write-only LSI.

The eight bits next to the slave address is a control byte. The first one bit is CO: consecutive command setting bit and the next one bit is RS: command/data setting bit (the remaining six bits are the Don't care bits).

When CO = "0": Means the last control byte.

When CO = "1": Means the control bytes are successively input.

When RS = "0": Means the data to be input next is the command data.

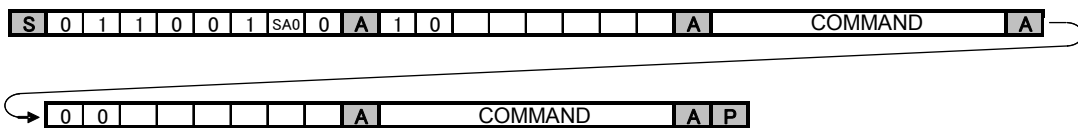
When RS = "1": Means the data to be input next is the display data.

The display data can be successively input.

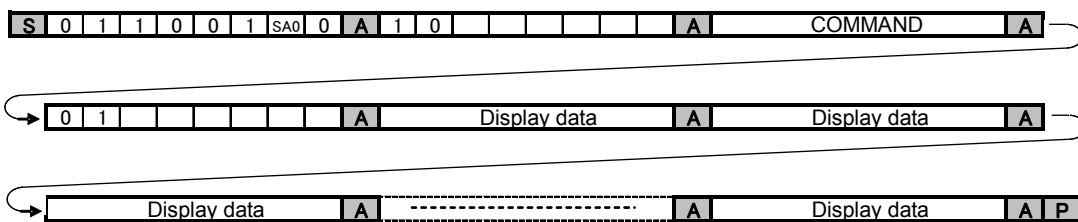
Example of Data Setting

- When inputting two commands

When inputting two commands



- When inputting the command and display data



Data write method

• Serial interface

The data is written to the address set by the data write setting command (F3).

For the Serial interface, the data is written in units of 160 bits.

Written from D160 to SEG1, D159 to SEG2, ..., D2 to SEG159, and D1 to SEG160.

| | MSB | | | | Segment output | | | | | | | | | | | | LSB |
|------|------|------|------|------|----------------|-----|-----|-----|-----|-----|-----|-----|-----|--|--|--|-----|
| | 1 | 2 | 3 | 4 | 72 | 73 | 74 | 75 | 76 | 77 | 78 | 79 | 80 | | | | |
| COM1 | D160 | D159 | D158 | D157 | D89 | D88 | D87 | D86 | D85 | D84 | D83 | D82 | D81 | | | | |
| COM2 | D160 | D159 | D158 | D157 | D89 | D88 | D87 | D86 | D85 | D84 | D83 | D82 | D81 | | | | |
| COM3 | D160 | D159 | D158 | D157 | D89 | D88 | D87 | D86 | D85 | D84 | D83 | D82 | D81 | | | | |
| COM4 | D160 | D159 | D158 | D157 | D89 | D88 | D87 | D86 | D85 | D84 | D83 | D82 | D81 | | | | |

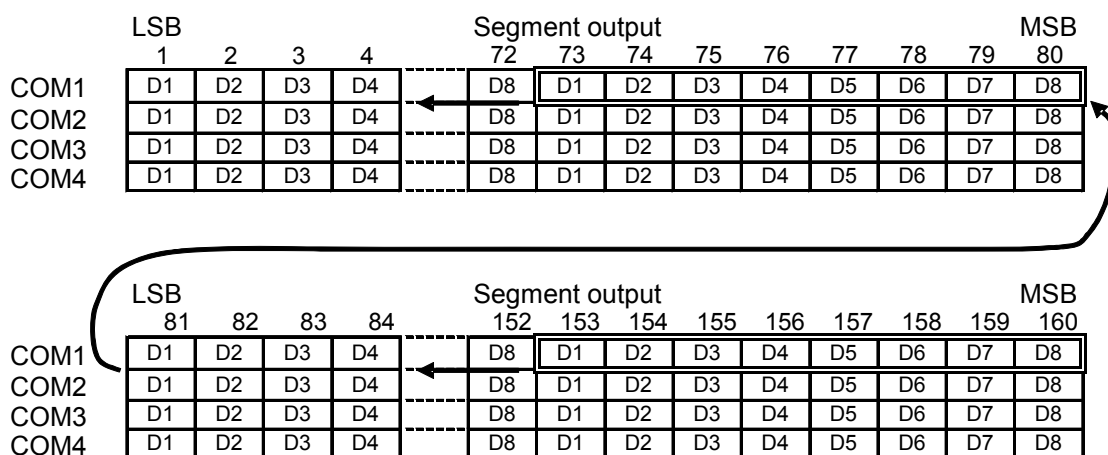
| | MSB | | | | Segment output | | | | | | | | | | | | LSB |
|------|-----|-----|-----|-----|----------------|-----|-----|-----|-----|-----|-----|-----|-----|--|--|--|-----|
| | 81 | 82 | 83 | 84 | 152 | 153 | 154 | 155 | 156 | 157 | 158 | 159 | 160 | | | | |
| COM1 | D80 | D79 | D78 | D77 | D9 | D8 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | | | | |
| COM2 | D80 | D79 | D78 | D77 | D9 | D8 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | | | | |
| COM3 | D80 | D79 | D78 | D77 | D9 | D8 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | | | | |
| COM4 | D80 | D79 | D78 | D77 | D9 | D8 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | | | | |

• I²C interface

The data is written to the address set by the slave address.

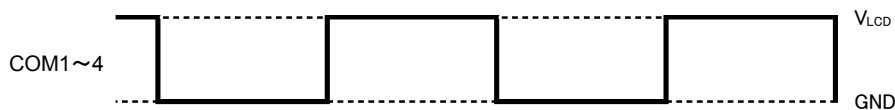
For the I²C interface, the data is written to the specified address starting with the LSB side in units of 8 bits.

(The data is written in the order from SEG153-160, SEG145-SEG152, ..., SEG9-16, and SEG1-SEG8.)



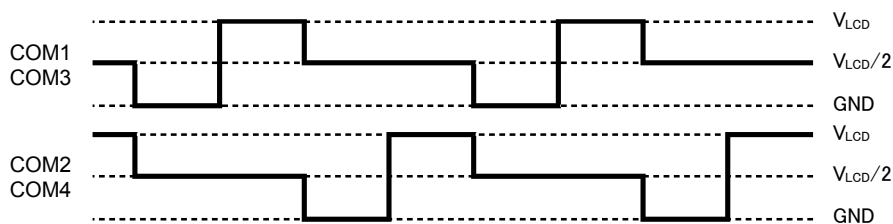
● Common waveforms

(1) At static

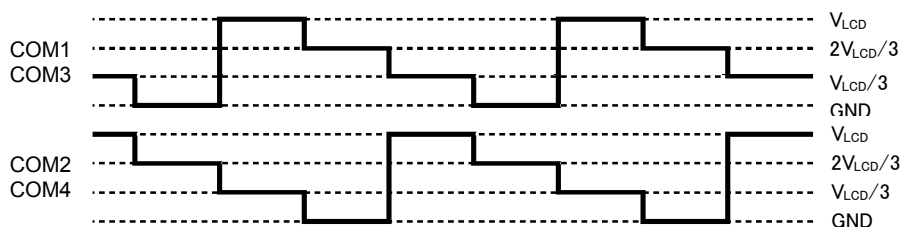


(2) At 1/2-duty

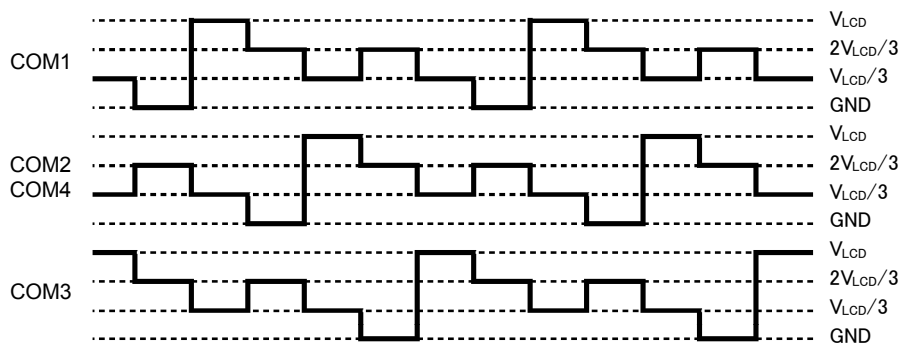
At 1/2-bias



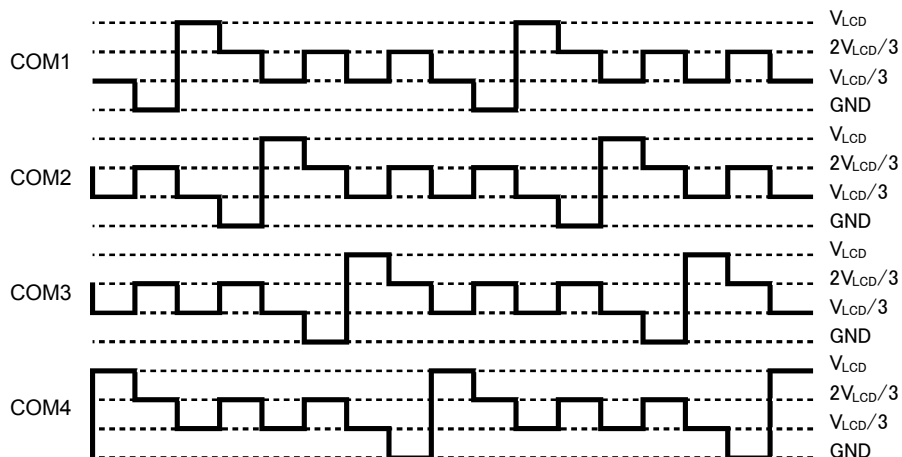
At 1/3-bias



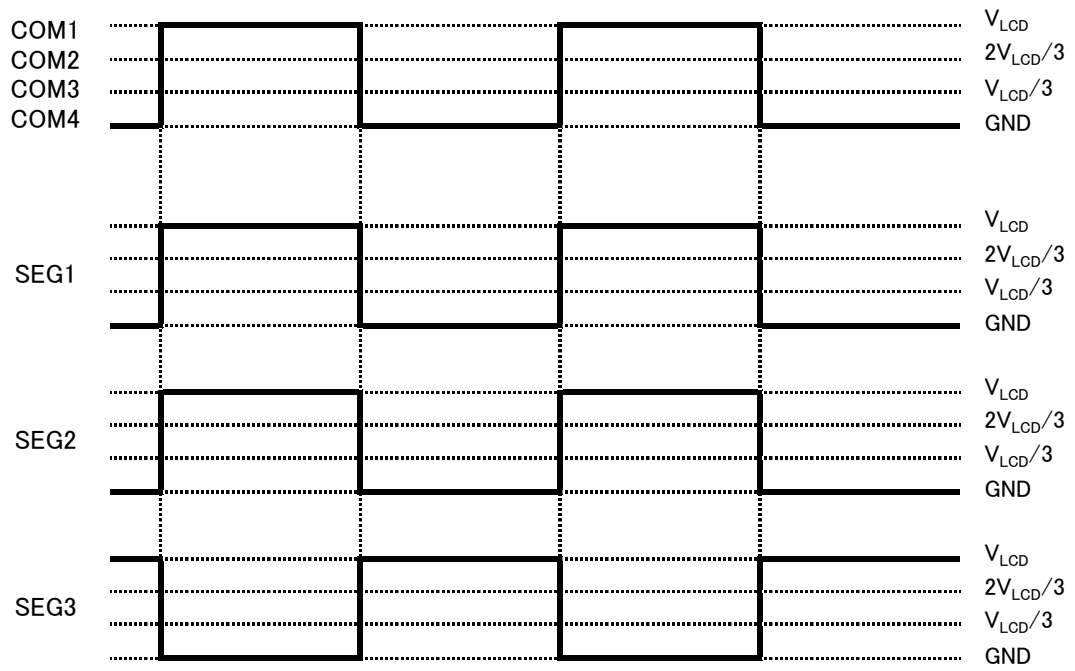
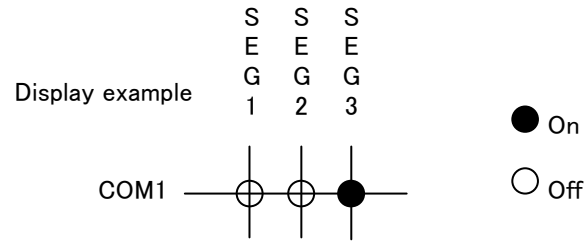
(3) At 1/3-duty



(4) At 1/4-duty

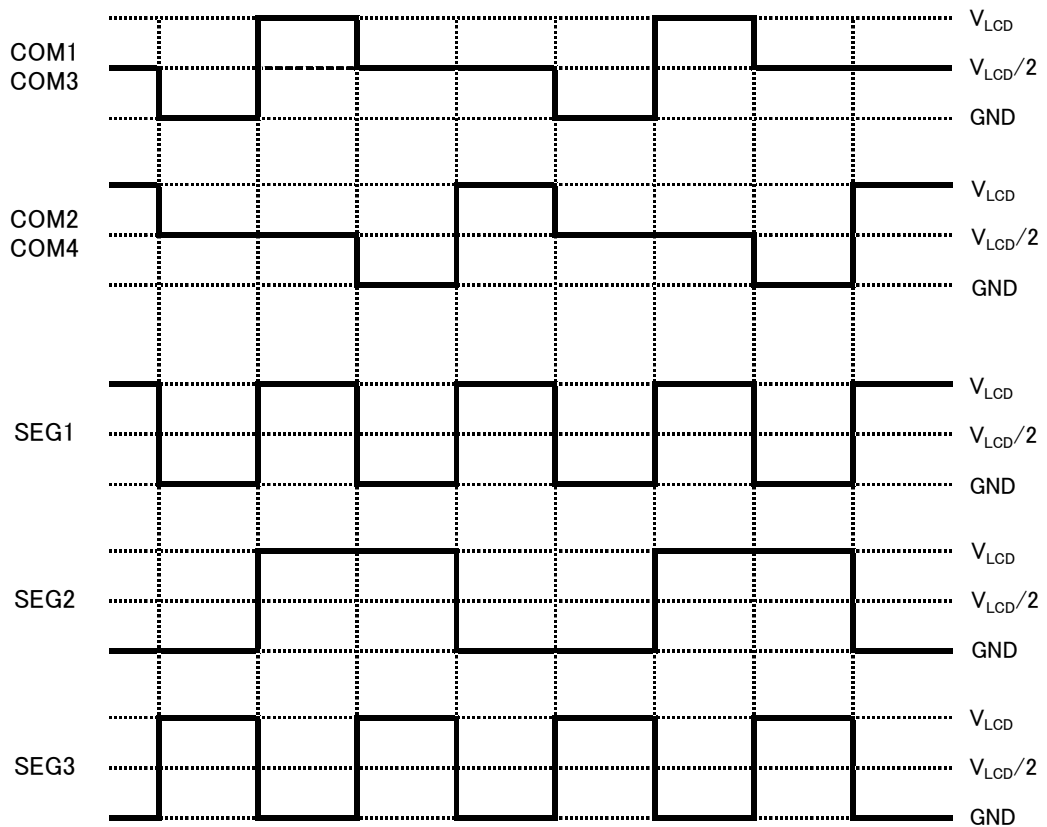
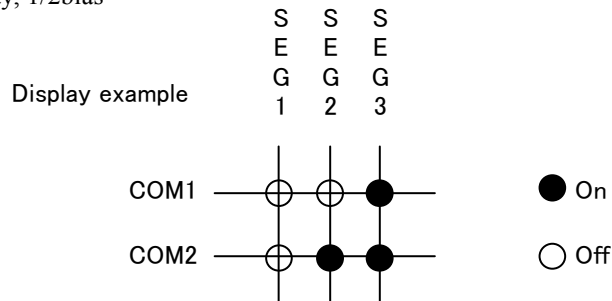


- Common segment output waveform
 - At Static



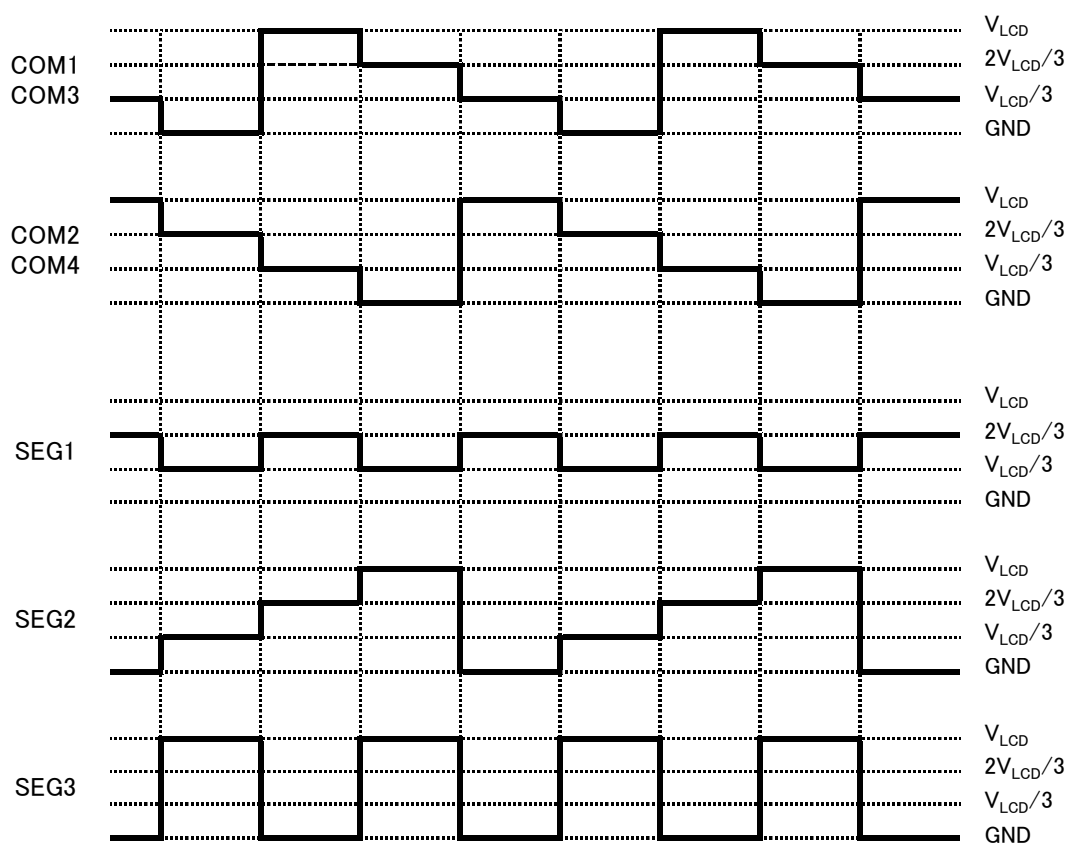
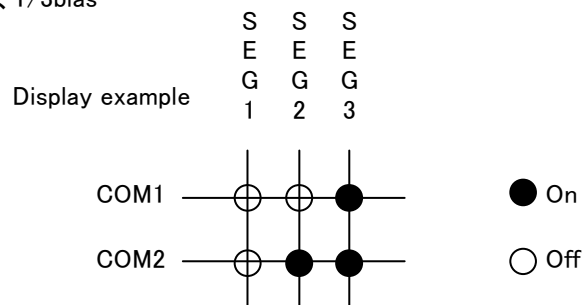
● Common and segment output waveforms

•At 1/2Duty, 1/2bias



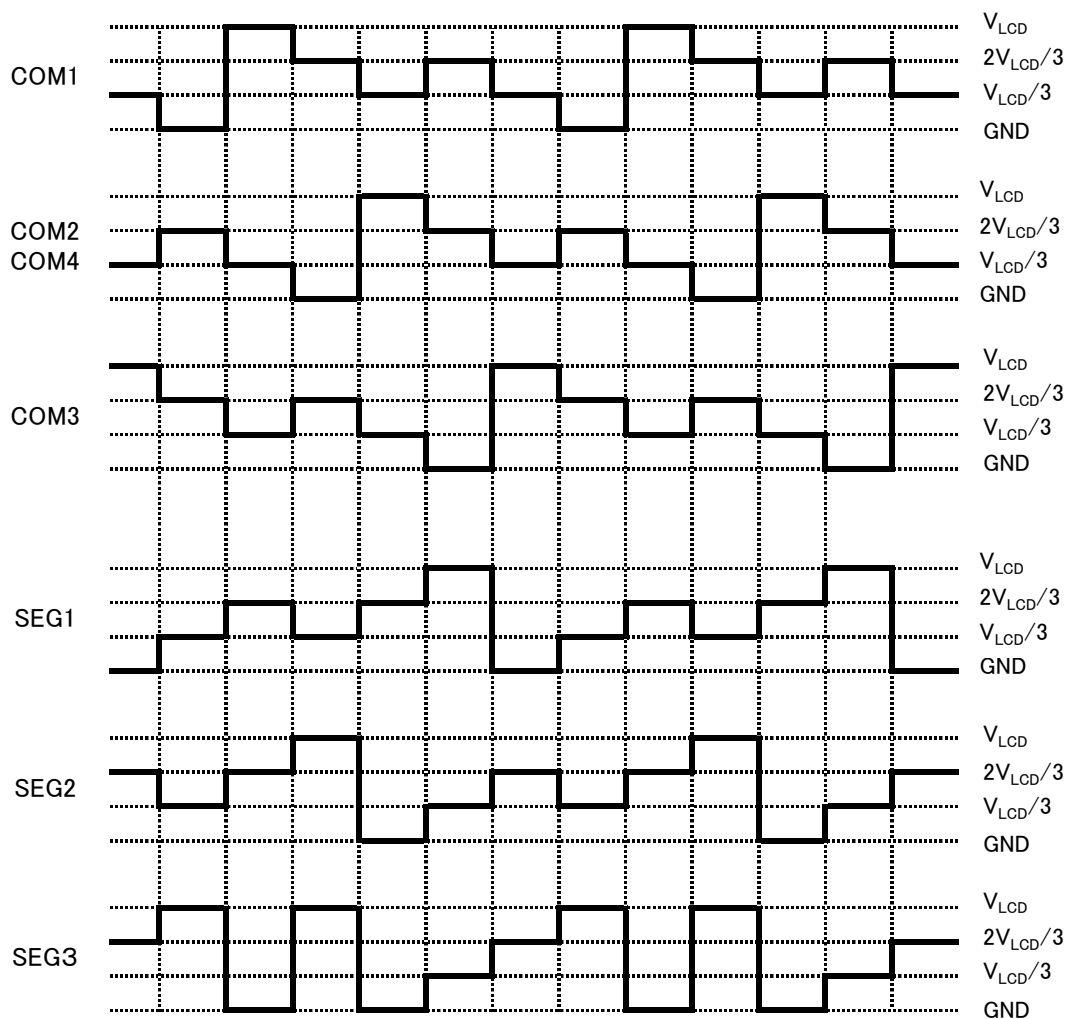
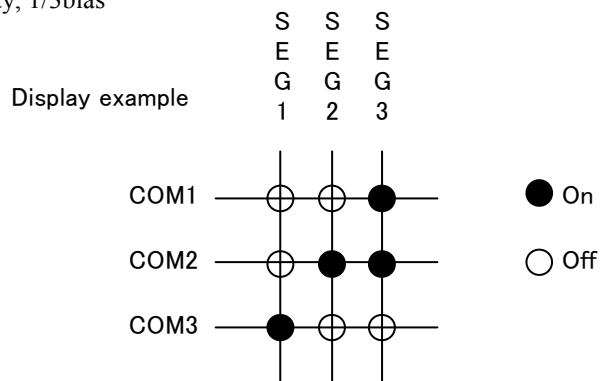
● Common segment output waveform

• At 1/2 Duty, 1/3bias

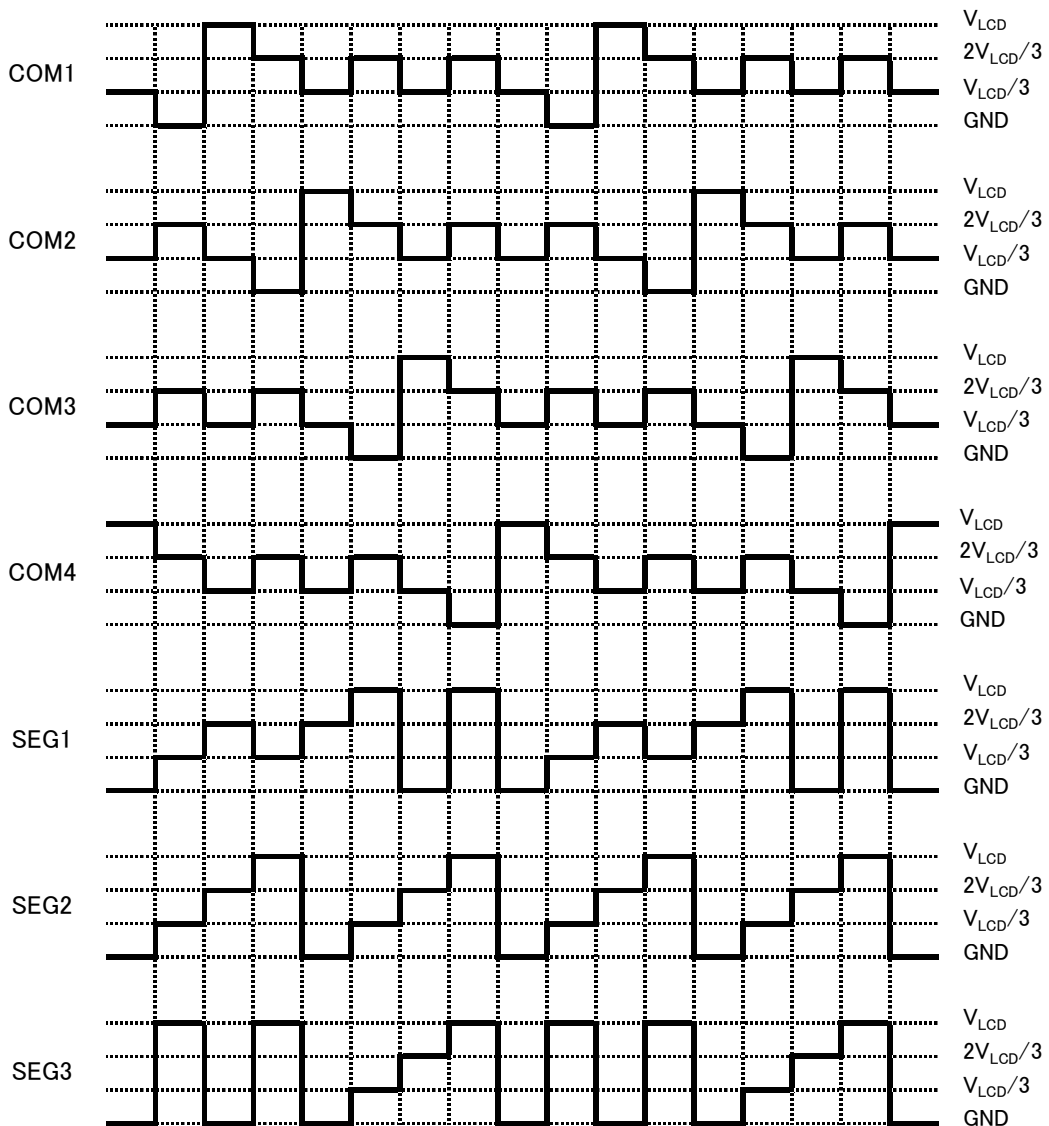
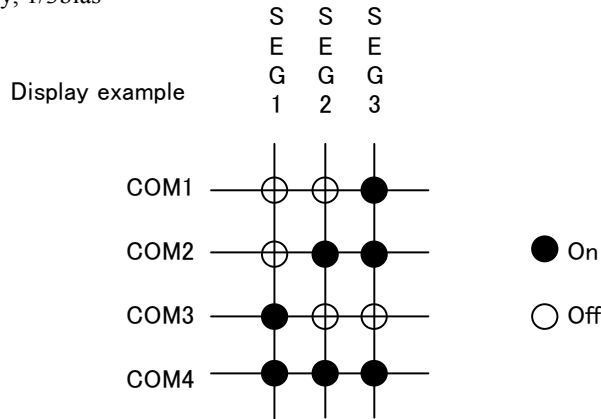


● Common and segment output waveforms

• At 1/3Duty, 1/3bias



● Common and segment output waveforms
 • At 1/4Duty, 1/3bias

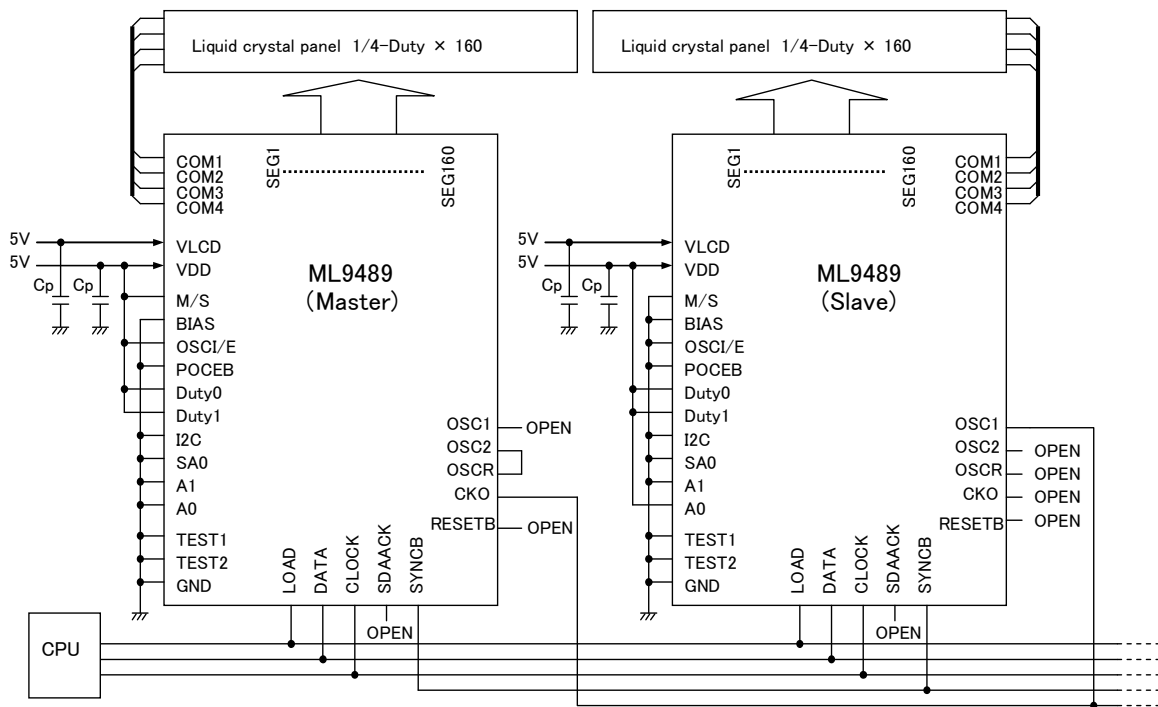


EXAMPLE OF APPLICATION CIRCUIT

Cascade configuration 1

Serial interface
 Internal CR oscillator circuit used
 1/4Duty
 RESETB pin is open.
 The common waveform of master and slave chip is active.

[External component]
 $C_p = 0.1 \text{ } [\mu\text{F}]$ (bypass capacitor between power supplies)

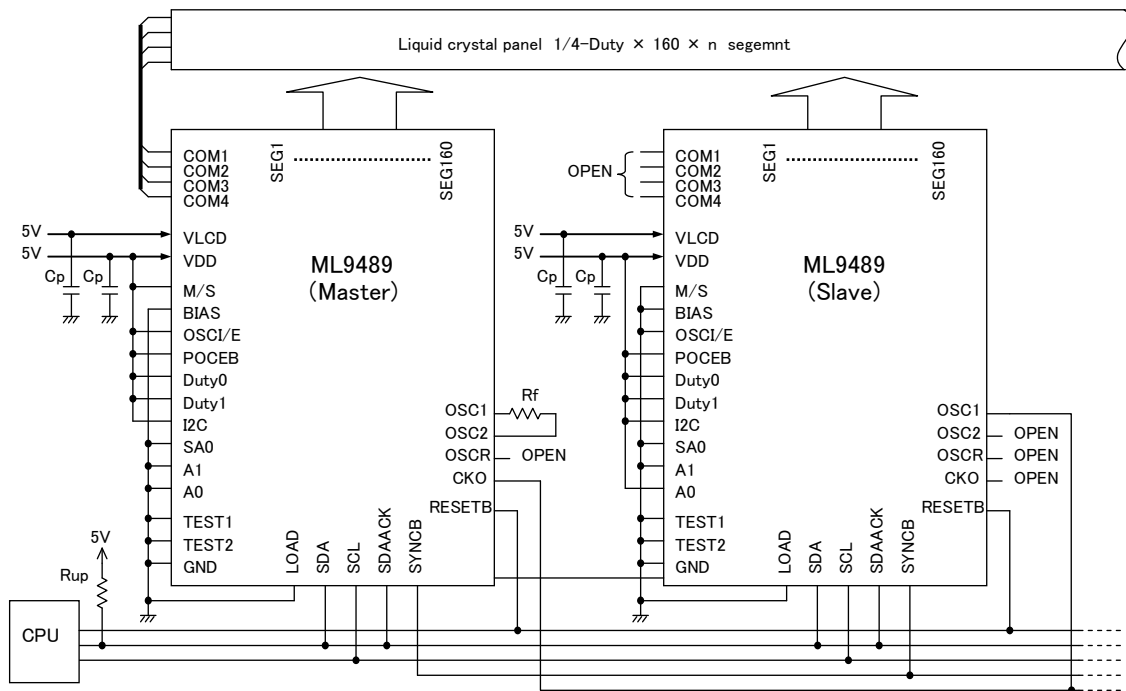


Cascade configuration 2

- I²C interface
- External Rf-based CR oscillator circuit used
- 1/4Duty
- External RESETB signal input
- The common waveform of slave chip is open.

[External component]

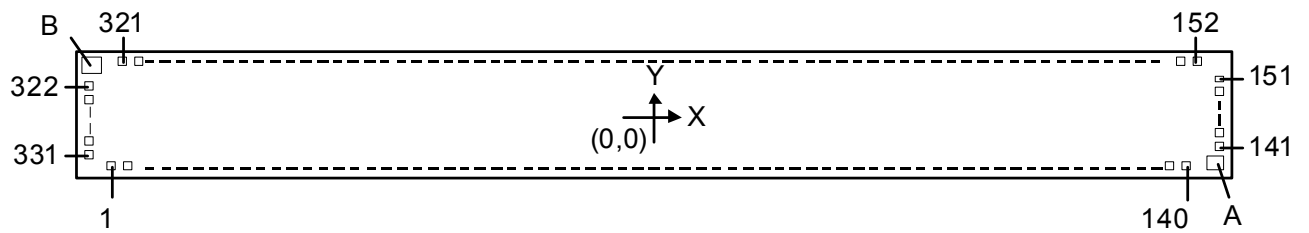
- Cp = 0.1 [μF] (bypass capacitor between power supplies),
- Rf = 470 [kΩ] (external R, resistor for CR oscillator circuit),
- Rup = Resistor for SDA data bus pull-up



PAD CONFIGURATION

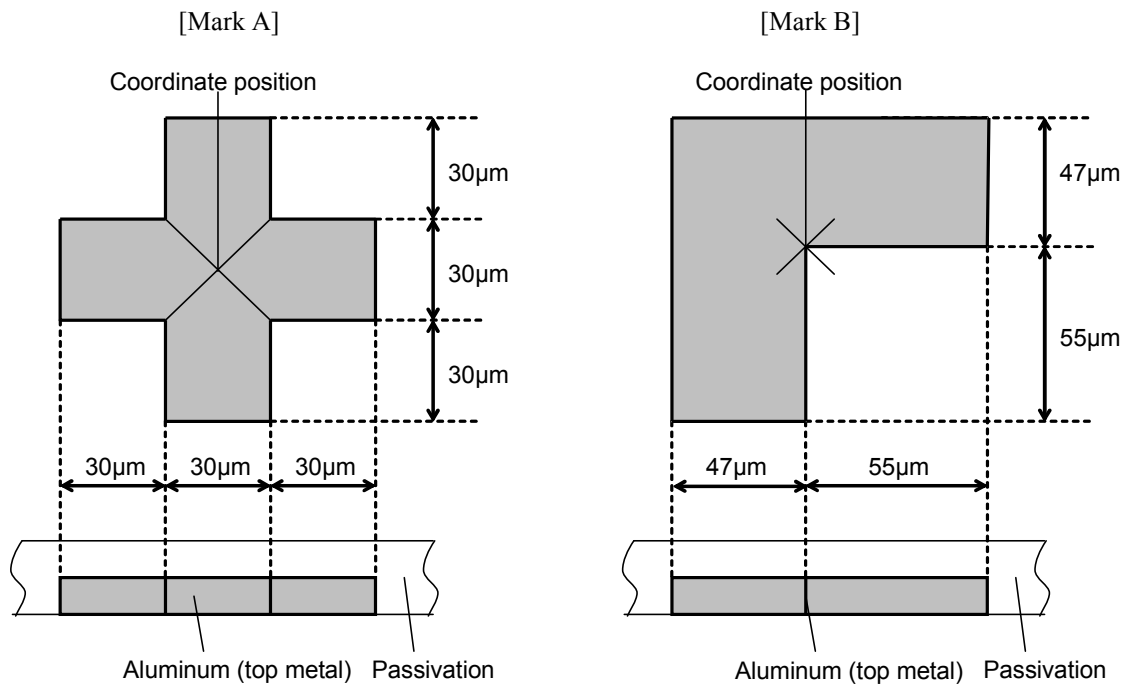
Pad layout (pattern face)

Chip size : 8.84 mm x 0.90 mm
 Chip thickness : 400 μm ± 20 μm
 Minimum bump pitch : 50 μm
 Bump height : 15 μm ± 3 μm



Bump and alignment mark dimensions (pattern face)

PAD No.1~140 : 35 μm x 72 μm
 PAD No.141~331 : 30 μm x 84 μm
 Alignment marks A and B : See below



| Alignment mark | X-coordinate (μm) | Y-coordinate (μm) |
|----------------|-------------------|-------------------|
| Mark A | 4308.9 | -312.1 |
| Mark B | -4305.9 | 305.9 |

Pad center coordinates

| Pad number | Pad name | X-coordinate (μm) | Y-coordinate (μm) | Pad number | Pad name | X-coordinate (μm) | Y-coordinate (μm) |
|------------|-----------|-------------------|-------------------|------------|------------|-------------------|-------------------|
| 1 | DUMMY | -4236.2 | -312.1 | 40 | DATA(SDA) | -1863 | -312.1 |
| 2 | DUMMY | -4176.2 | -312.1 | 41 | CLOCK(SCL) | -1767.8 | -312.1 |
| 3 | DUMMY | -4116.2 | -312.1 | 42 | CLOCK(SCL) | -1711.8 | -312.1 |
| 4 | DUMMY | -4056.2 | -312.1 | 43 | CLOCK(SCL) | -1655.8 | -312.1 |
| 5 | DUMMY | -3996.2 | -312.1 | 44 | CLOCK(SCL) | -1599.8 | -312.1 |
| 6 | DUMMY | -3936.2 | -312.1 | 45 | CLOCK(SCL) | -1543.8 | -312.1 |
| 7 | GNDO | -3871 | -312.1 | 46 | LOAD | -1448.6 | -312.1 |
| 8 | GNDO | -3815 | -312.1 | 47 | LOAD | -1392.6 | -312.1 |
| 9 | Duty1 | -3749 | -312.1 | 48 | LOAD | -1336.6 | -312.1 |
| 10 | Duty1 | -3693 | -312.1 | 49 | LOAD | -1280.6 | -312.1 |
| 11 | Duty1 | -3637 | -312.1 | 50 | LOAD | -1224.6 | -312.1 |
| 12 | Duty1 | -3581 | -312.1 | 51 | GND | -1154.4 | -312.1 |
| 13 | Duty0 | -3510.4 | -312.1 | 52 | GND | -1084.2 | -312.1 |
| 14 | Duty0 | -3454.4 | -312.1 | 53 | GND | -1028.2 | -312.1 |
| 15 | Duty0 | -3398.4 | -312.1 | 54 | GND | -972.2 | -312.1 |
| 16 | Duty0 | -3342.4 | -312.1 | 55 | GND | -916.2 | -312.1 |
| 17 | A0 | -3272 | -312.1 | 56 | GND | -860.2 | -312.1 |
| 18 | A0 | -3216 | -312.1 | 57 | GND | -804.2 | -312.1 |
| 19 | A0 | -3160 | -312.1 | 58 | GND | -748.2 | -312.1 |
| 20 | A0 | -3104 | -312.1 | 59 | VDD | -653 | -312.1 |
| 21 | A1 | -3033.8 | -312.1 | 60 | VDD | -597 | -312.1 |
| 22 | A1 | -2977.8 | -312.1 | 61 | VDD | -541 | -312.1 |
| 23 | A1 | -2921.8 | -312.1 | 62 | VDD | -485 | -312.1 |
| 24 | A1 | -2865.8 | -312.1 | 63 | VDD | -429 | -312.1 |
| 25 | SA0 | -2795.6 | -312.1 | 64 | VDD | -373 | -312.1 |
| 26 | SA0 | -2739.6 | -312.1 | 65 | VDD | -317 | -312.1 |
| 27 | SA0 | -2683.6 | -312.1 | 66 | VLCD | -221.8 | -312.1 |
| 28 | SA0 | -2627.6 | -312.1 | 67 | VLCD | -165.8 | -312.1 |
| 29 | VDDO | -2557.4 | -312.1 | 68 | VLCD | -109.8 | -312.1 |
| 30 | VDDO | -2501.4 | -312.1 | 69 | VLCD | -53.8 | -312.1 |
| 31 | SDAACK | -2406.2 | -312.1 | 70 | VLCD | 2.2 | -312.1 |
| 32 | SDAACK | -2350.2 | -312.1 | 71 | VLCD | 58.2 | -312.1 |
| 33 | SDAACK | -2294.2 | -312.1 | 72 | VLCD | 114.2 | -312.1 |
| 34 | SDAACK | -2238.2 | -312.1 | 73 | RESETB | 209.6 | -312.1 |
| 35 | SDAACK | -2182.2 | -312.1 | 74 | RESETB | 265.6 | -312.1 |
| 36 | DATA(SDA) | -2087 | -312.1 | 75 | RESETB | 321.6 | -312.1 |
| 37 | DATA(SDA) | -2031 | -312.1 | 76 | RESETB | 377.6 | -312.1 |
| 38 | DATA(SDA) | -1975 | -312.1 | 77 | RESETB | 433.6 | -312.1 |
| 39 | DATA(SDA) | -1919 | -312.1 | 78 | OSC1 | 503.8 | -312.1 |

| Pad number | Pad name | X-coordinate (μm) | Y-coordinate (μm) | Pad number | Pad name | X-coordinate (μm) | Y-coordinate (μm) |
|------------|----------|-------------------|-------------------|------------|----------|-------------------|-------------------|
| 79 | OSC1 | 559.8 | -312.1 | 124 | BIAS | 3251.4 | -312.1 |
| 80 | OSC1 | 615.8 | -312.1 | 125 | TEST2 | 3321.6 | -312.1 |
| 81 | OSC1 | 671.8 | -312.1 | 126 | TEST2 | 3377.6 | -312.1 |
| 82 | OSC1 | 727.8 | -312.1 | 127 | TEST2 | 3433.6 | -312.1 |
| 83 | OSC2 | 790.4 | -312.1 | 128 | TEST2 | 3489.6 | -312.1 |
| 84 | OSC2 | 846.4 | -312.1 | 129 | TEST1 | 3559.8 | -312.1 |
| 85 | OSC2 | 902.4 | -312.1 | 130 | TEST1 | 3615.8 | -312.1 |
| 86 | OSC2 | 958.4 | -312.1 | 131 | TEST1 | 3671.8 | -312.1 |
| 87 | OSC2 | 1014.4 | -312.1 | 132 | TEST1 | 3727.8 | -312.1 |
| 88 | OSCR | 1090.4 | -312.1 | 133 | GNDO | 3798 | -312.1 |
| 89 | OSCR | 1146.4 | -312.1 | 134 | GNDO | 3854 | -312.1 |
| 90 | OSCR | 1202.4 | -312.1 | 135 | DUMMY | 3924.2 | -312.1 |
| 91 | OSCR | 1258.4 | -312.1 | 136 | DUMMY | 3984.2 | -312.1 |
| 92 | OSCR | 1314.4 | -312.1 | 137 | DUMMY | 4044.2 | -312.1 |
| 93 | CKO | 1389.8 | -312.1 | 138 | DUMMY | 4104.2 | -312.1 |
| 94 | CKO | 1445.8 | -312.1 | 139 | DUMMY | 4164.2 | -312.1 |
| 95 | CKO | 1501.8 | -312.1 | 140 | DUMMY | 4224.2 | -312.1 |
| 96 | CKO | 1557.8 | -312.1 | 141 | DUMMY | 4308.9 | -232.2 |
| 97 | CKO | 1613.8 | -312.1 | 142 | DUMMY | 4308.9 | -182.2 |
| 98 | SYNCB | 1694 | -312.1 | 143 | COM1 | 4308.9 | -132.2 |
| 99 | SYNCB | 1750 | -312.1 | 144 | COM2 | 4308.9 | -82.2 |
| 100 | SYNCB | 1806 | -312.1 | 145 | COM3 | 4308.9 | -32.2 |
| 101 | SYNCB | 1862 | -312.1 | 146 | COM4 | 4308.9 | 17.8 |
| 102 | SYNCB | 1918 | -312.1 | 147 | DUMMY | 4308.9 | 67.8 |
| 103 | VDDO | 2004.4 | -312.1 | 148 | DUMMY | 4308.9 | 117.8 |
| 104 | VDDO | 2060.4 | -312.1 | 149 | DUMMY | 4308.9 | 167.8 |
| 105 | I2C | 2130.6 | -312.1 | 150 | DUMMY | 4308.9 | 217.8 |
| 106 | I2C | 2186.6 | -312.1 | 151 | DUMMY | 4308.9 | 267.8 |
| 107 | I2C | 2242.6 | -312.1 | 152 | DUMMY | 4225 | 308.9 |
| 108 | I2C | 2298.6 | -312.1 | 153 | DUMMY | 4175 | 308.9 |
| 109 | M/S | 2368.8 | -312.1 | 154 | DUMMY | 4125 | 308.9 |
| 110 | M/S | 2424.8 | -312.1 | 155 | SEG1 | 4075 | 308.9 |
| 111 | M/S | 2480.8 | -312.1 | 156 | SEG2 | 4025 | 308.9 |
| 112 | M/S | 2536.8 | -312.1 | 157 | SEG3 | 3975 | 308.9 |
| 113 | POCEB | 2607 | -312.1 | 158 | SEG4 | 3925 | 308.9 |
| 114 | POCEB | 2663 | -312.1 | 159 | SEG5 | 3875 | 308.9 |
| 115 | POCEB | 2719 | -312.1 | 160 | SEG6 | 3825 | 308.9 |
| 116 | POCEB | 2775 | -312.1 | 161 | SEG7 | 3775 | 308.9 |
| 117 | OSCI/E | 2845.2 | -312.1 | 162 | SEG8 | 3725 | 308.9 |
| 118 | OSCI/E | 2901.2 | -312.1 | 163 | SEG9 | 3675 | 308.9 |
| 119 | OSCI/E | 2957.2 | -312.1 | 164 | SEG10 | 3625 | 308.9 |
| 120 | OSCI/E | 3013.2 | -312.1 | 165 | SEG11 | 3575 | 308.9 |
| 121 | BIAS | 3083.4 | -312.1 | 166 | SEG12 | 3525 | 308.9 |
| 122 | BIAS | 3139.4 | -312.1 | 167 | SEG13 | 3475 | 308.9 |
| 123 | BIAS | 3195.4 | -312.1 | 168 | SEG14 | 3425 | 308.9 |

ML9489

| Pad number | Pad name | X-coordinate (μm) | Y-coordinate (μm) | Pad number | Pad name | X-coordinate (μm) | Y-coordinate (μm) |
|------------|----------|-------------------|-------------------|------------|----------|-------------------|-------------------|
| 169 | SEG15 | 3375 | 308.9 | 214 | SEG60 | 1125 | 308.9 |
| 170 | SEG16 | 3325 | 308.9 | 215 | SEG61 | 1075 | 308.9 |
| 171 | SEG17 | 3275 | 308.9 | 216 | SEG62 | 1025 | 308.9 |
| 172 | SEG18 | 3225 | 308.9 | 217 | SEG63 | 975 | 308.9 |
| 173 | SEG19 | 3175 | 308.9 | 218 | SEG64 | 925 | 308.9 |
| 174 | SEG20 | 3125 | 308.9 | 219 | SEG65 | 875 | 308.9 |
| 175 | SEG21 | 3075 | 308.9 | 220 | SEG66 | 825 | 308.9 |
| 176 | SEG22 | 3025 | 308.9 | 221 | SEG67 | 775 | 308.9 |
| 177 | SEG23 | 2975 | 308.9 | 222 | SEG68 | 725 | 308.9 |
| 178 | SEG24 | 2925 | 308.9 | 223 | SEG69 | 675 | 308.9 |
| 179 | SEG25 | 2875 | 308.9 | 224 | SEG70 | 625 | 308.9 |
| 180 | SEG26 | 2825 | 308.9 | 225 | SEG71 | 575 | 308.9 |
| 181 | SEG27 | 2775 | 308.9 | 226 | SEG72 | 525 | 308.9 |
| 182 | SEG28 | 2725 | 308.9 | 227 | SEG73 | 475 | 308.9 |
| 183 | SEG29 | 2675 | 308.9 | 228 | SEG74 | 425 | 308.9 |
| 184 | SEG30 | 2625 | 308.9 | 229 | SEG75 | 375 | 308.9 |
| 185 | SEG31 | 2575 | 308.9 | 230 | SEG76 | 325 | 308.9 |
| 186 | SEG32 | 2525 | 308.9 | 231 | SEG77 | 275 | 308.9 |
| 187 | SEG33 | 2475 | 308.9 | 232 | SEG78 | 225 | 308.9 |
| 188 | SEG34 | 2425 | 308.9 | 233 | SEG79 | 175 | 308.9 |
| 189 | SEG35 | 2375 | 308.9 | 234 | SEG80 | 125 | 308.9 |
| 190 | SEG36 | 2325 | 308.9 | 235 | COM1 | 75 | 308.9 |
| 191 | SEG37 | 2275 | 308.9 | 236 | COM2 | 25 | 308.9 |
| 192 | SEG38 | 2225 | 308.9 | 237 | COM3 | -25 | 308.9 |
| 193 | SEG39 | 2175 | 308.9 | 238 | COM4 | -75 | 308.9 |
| 194 | SEG40 | 2125 | 308.9 | 239 | SEG81 | -125 | 308.9 |
| 195 | SEG41 | 2075 | 308.9 | 240 | SEG82 | -175 | 308.9 |
| 196 | SEG42 | 2025 | 308.9 | 241 | SEG83 | -225 | 308.9 |
| 197 | SEG43 | 1975 | 308.9 | 242 | SEG84 | -275 | 308.9 |
| 198 | SEG44 | 1925 | 308.9 | 243 | SEG85 | -325 | 308.9 |
| 199 | SEG45 | 1875 | 308.9 | 244 | SEG86 | -375 | 308.9 |
| 200 | SEG46 | 1825 | 308.9 | 245 | SEG87 | -425 | 308.9 |
| 201 | SEG47 | 1775 | 308.9 | 246 | SEG88 | -475 | 308.9 |
| 202 | SEG48 | 1725 | 308.9 | 247 | SEG89 | -525 | 308.9 |
| 203 | SEG49 | 1675 | 308.9 | 248 | SEG90 | -575 | 308.9 |
| 204 | SEG50 | 1625 | 308.9 | 249 | SEG91 | -625 | 308.9 |
| 205 | SEG51 | 1575 | 308.9 | 250 | SEG92 | -675 | 308.9 |
| 206 | SEG52 | 1525 | 308.9 | 251 | SEG93 | -725 | 308.9 |
| 207 | SEG53 | 1475 | 308.9 | 252 | SEG94 | -775 | 308.9 |
| 208 | SEG54 | 1425 | 308.9 | 253 | SEG95 | -825 | 308.9 |
| 209 | SEG55 | 1375 | 308.9 | 254 | SEG96 | -875 | 308.9 |
| 210 | SEG56 | 1325 | 308.9 | 255 | SEG97 | -925 | 308.9 |
| 211 | SEG57 | 1275 | 308.9 | 256 | SEG98 | -975 | 308.9 |
| 212 | SEG58 | 1225 | 308.9 | 257 | SEG99 | -1025 | 308.9 |
| 213 | SEG59 | 1175 | 308.9 | 258 | SEG100 | -1075 | 308.9 |
| 259 | SEG101 | -1125 | 308.9 | 304 | SEG146 | -3375 | 308.9 |
| 260 | SEG102 | -1175 | 308.9 | 305 | SEG147 | -3425 | 308.9 |
| 261 | SEG103 | -1225 | 308.9 | 306 | SEG148 | -3475 | 308.9 |
| 262 | SEG104 | -1275 | 308.9 | 307 | SEG149 | -3525 | 308.9 |

| Pad number | Pad name | X-coordinate (μm) | Y-coordinate (μm) | Pad number | Pad name | X-coordinate (μm) | Y-coordinate (μm) |
|------------|----------|-------------------|-------------------|------------|----------|-------------------|-------------------|
| 263 | SEG105 | -1325 | 308.9 | 308 | SEG150 | -3575 | 308.9 |
| 264 | SEG106 | -1375 | 308.9 | 309 | SEG151 | -3625 | 308.9 |
| 265 | SEG107 | -1425 | 308.9 | 310 | SEG152 | -3675 | 308.9 |
| 266 | SEG108 | -1475 | 308.9 | 311 | SEG153 | -3725 | 308.9 |
| 267 | SEG109 | -1525 | 308.9 | 312 | SEG154 | -3775 | 308.9 |
| 268 | SEG110 | -1575 | 308.9 | 313 | SEG155 | -3825 | 308.9 |
| 269 | SEG111 | -1625 | 308.9 | 314 | SEG156 | -3875 | 308.9 |
| 270 | SEG112 | -1675 | 308.9 | 315 | SEG157 | -3925 | 308.9 |
| 271 | SEG113 | -1725 | 308.9 | 316 | SEG158 | -3975 | 308.9 |
| 272 | SEG114 | -1775 | 308.9 | 317 | SEG159 | -4025 | 308.9 |
| 273 | SEG115 | -1825 | 308.9 | 318 | SEG160 | -4075 | 308.9 |
| 274 | SEG116 | -1875 | 308.9 | 319 | DUMMY | -4125 | 308.9 |
| 275 | SEG117 | -1925 | 308.9 | 320 | DUMMY | -4175 | 308.9 |
| 276 | SEG118 | -1975 | 308.9 | 321 | DUMMY | -4225 | 308.9 |
| 277 | SEG119 | -2025 | 308.9 | 322 | DUMMY | -4308.9 | 203.2 |
| 278 | SEG120 | -2075 | 308.9 | 323 | DUMMY | -4308.9 | 153.2 |
| 279 | SEG121 | -2125 | 308.9 | 324 | DUMMY | -4308.9 | 103.2 |
| 280 | SEG122 | -2175 | 308.9 | 325 | DUMMY | -4308.9 | 53.2 |
| 281 | SEG123 | -2225 | 308.9 | 326 | COM4 | -4308.9 | 3.2 |
| 282 | SEG124 | -2275 | 308.9 | 327 | COM3 | -4308.9 | -46.8 |
| 283 | SEG125 | -2325 | 308.9 | 328 | COM2 | -4308.9 | -96.8 |
| 284 | SEG126 | -2375 | 308.9 | 329 | COM1 | -4308.9 | -146.8 |
| 285 | SEG127 | -2425 | 308.9 | 330 | DUMMY | -4308.9 | -196.8 |
| 286 | SEG128 | -2475 | 308.9 | 331 | DUMMY | -4308.9 | -246.8 |
| 287 | SEG129 | -2525 | 308.9 | | | | |
| 288 | SEG130 | -2575 | 308.9 | | | | |
| 289 | SEG131 | -2625 | 308.9 | | | | |
| 290 | SEG132 | -2675 | 308.9 | | | | |
| 291 | SEG133 | -2725 | 308.9 | | | | |
| 292 | SEG134 | -2775 | 308.9 | | | | |
| 293 | SEG135 | -2825 | 308.9 | | | | |
| 294 | SEG136 | -2875 | 308.9 | | | | |
| 295 | SEG137 | -2925 | 308.9 | | | | |
| 296 | SEG138 | -2975 | 308.9 | | | | |
| 297 | SEG139 | -3025 | 308.9 | | | | |
| 298 | SEG140 | -3075 | 308.9 | | | | |
| 299 | SEG141 | -3125 | 308.9 | | | | |
| 300 | SEG142 | -3175 | 308.9 | | | | |
| 301 | SEG143 | -3225 | 308.9 | | | | |
| 302 | SEG144 | -3275 | 308.9 | | | | |
| 303 | SEG145 | -3325 | 308.9 | | | | |

REVISION HISTORY

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